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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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JAN 16 2002

In re Patent Application of:

Our Ref.: P/2041-61

TSUNEMASU et al.

Date: December 4, 2001

Serial No.: 09/872,256

Group Art Unit: 2833

Filed: 6/1/01

Examiner: --

For: MOUNTING STRUCTURE OF SEMICONDUCTOR PACKAGE

Assistant Commissioner of Patents  
Washington, D.C. 20231

**SUBMISSION OF SUBSTITUTE DECLARATION**

Sir:

Applicants submit herewith a substitute Declaration which corrects the filing date of the Japanese priority application.

**CERTIFICATE OF MAILING**

Respectfully submitted,

I hereby certify that this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to:  
Assistant Commissioner for Patents, Washington, D.C. 20231-9999, on December 4, 2001:

Steven I. Weisburd

Name of applicant, assignee or  
Registered Representative

Signature

December 4, 2001

Date of Signature

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